

CeraLink

Material Data Sheet

Product Class	S CeraLink B58031* 04.10.2019 5.04							
Date								
IMDS ID if available								
Version								
Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic	3B	PLZT others*)	98	106390-68-5	75.5		
Inner Electrode	Heavy Metal	1C12	Cu	100	7440-50-8	7.1		
Termination	Noble Metal	1D7	Ag	100	7440-22-4	1		
	Heavy Metal	1C14	Ni	100	7440-02-0	· ·	< 0,01	
	Heavy Metal	1C2	Cr	100	7440-47-3		< 0,01	
Contact	Steel and Iron	1A	Fe	64	7439-89-6	8.5	•	
			Ni	36	7440-02-0			
	Heavy Metal	1C12	Cu	100	7440-50-8	6.3		
	Noble Metal	1D7	Ag	100	7440-22-4	0.6		
Glue	Duromer	2D	Ероху	100		1		
				•	Sum of total	100		
sizes [mm] 10,9 x 4 x 7,9	weight range [g]	B58031I*						
7,1 x 4 x 7,9	1,3	B58031U*						
Not part of a Product	Class							
Contact	Ronner Christoph Important remarks:							
Division	PPD Q QM				1) The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are			
Address	8530 Deutschlandsberg			product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated.				
*) others: .(not declarab **) typical mass percent	Tel: +43 3462 800 2139 sle or prohibited substan tage of substance	mailto: functional.ppd-eqpm.db@t ces acc. GADSL)	dk-electronics.tdk.com	2) This Mate herein. We expressed the spresent know specifications, un AFFILIATES HEF WHETHER EXPRAND VALUES COREPRESENTATION	2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on out best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.			
of the European Parlian	ment and of the Council	of June 8 th , 2011 on the		re compatible with the req	uirements according to Art. 4 es in electrical and electronic ed	,	Directive 2011/65/EU	
□ Exemption 6 (b): Le □ Exemption 6 (c): Co □ Exemption 7 (a): Le □ Exemption 7 (c)-l: Le □ Exemption 7 (c)-li: Le □ Exemption 7 (c)-lii: Le □ Exemption 15: Le	ead as an alloying element in opper alloy containing up to ead in high melting temperat lectrical and electronic comp ead in dielectric ceramic in c ead in dielectric ceramic in c	n aluminium containing up to 4 % lead by weight; ure type solder (i.e. lead-bas onents containing lead in a apacitors for a rated voltage apacitors for a rated voltage viable electrical connection b	ed alloys containing 85 % by w	eight or more lead); ectric ceramic in capacitors, e.g her; DC;	g. piezoelectronic devices, or in a gl	ass or ceramic matrix compoun	d;	